

1. Test Item List -----	2
2. Test Configuration -----	3
3. Rom Temperature Test -----	4
3. Temperature Rise Test -----	6
4. High Temperature Storage Test -----	7
5. High Temperature Operation Test -----	8
6. Low Temperature Storage Test -----	9
7. Low Temperature Operation Test -----	10
8. Humidity Test -----	11
9. Temperature Shock Operation Test -----	12
10. Temperature Shock Non-operation Test -----	13
11. Cold Start And Hot Start Test -----	14

Sample Configuration:

Num	Item	Spec
01.	CPU:	Intel Celeron M Processor Yonah U2500 / 1.2GHz / 1.175V / FSB:533
02.	PCBA	T8NY1_PCB_ME_YNA
03.	BIOS	T8NY3.02D KBC BIOS Version:0.00.02
04.	Memory	Transcend 1GB / TS128M8Q64V6J / DDR2 667
05.	SATA II HDD	Fujitsu 80GB / MHZ2080BHG2 / 5400RPM
06.	WLAN + BT Module	AECO-AWM-S0021M
07.	LCD	CPT 10.2" LCD / CLAA102NA0ACW
08.	LED Driving Board	LITEMAX LID10B02
09.	Touch Panel	Liyitec PIC16F819 4-wire, Analog Resistive
10.	Modem	QCOM-ML3054 / Moto Chipset
11.	Battery	LI-ION Rechargeable Battery / DR202 DC11.1V / 7800mAh
12.	AC Adapter	LI SHIN 0335A2065 (Output: 20V / 3.25A)
13.	AC Power Input	110V / 60 Hz
14.	Test Software	Windows XP Embedded / Run Pass Mark Burn In Test 4.0 Pro

Test Date: 08-11-2009

Test Product: RTC-1000

Test Site: AAEON QA Internal Lab.

Temperature Measurement:

40 Channel Thermal Recorder:
YOKOGAWA Inc,
Model: DA100-13-1D
Date of Calibration: 12/13/08
Serial Number: 12A323190

Test Condition:

Ambient temperature: 25dC
Continuous running till thermal stability (within less than 1°C)

Test Software:

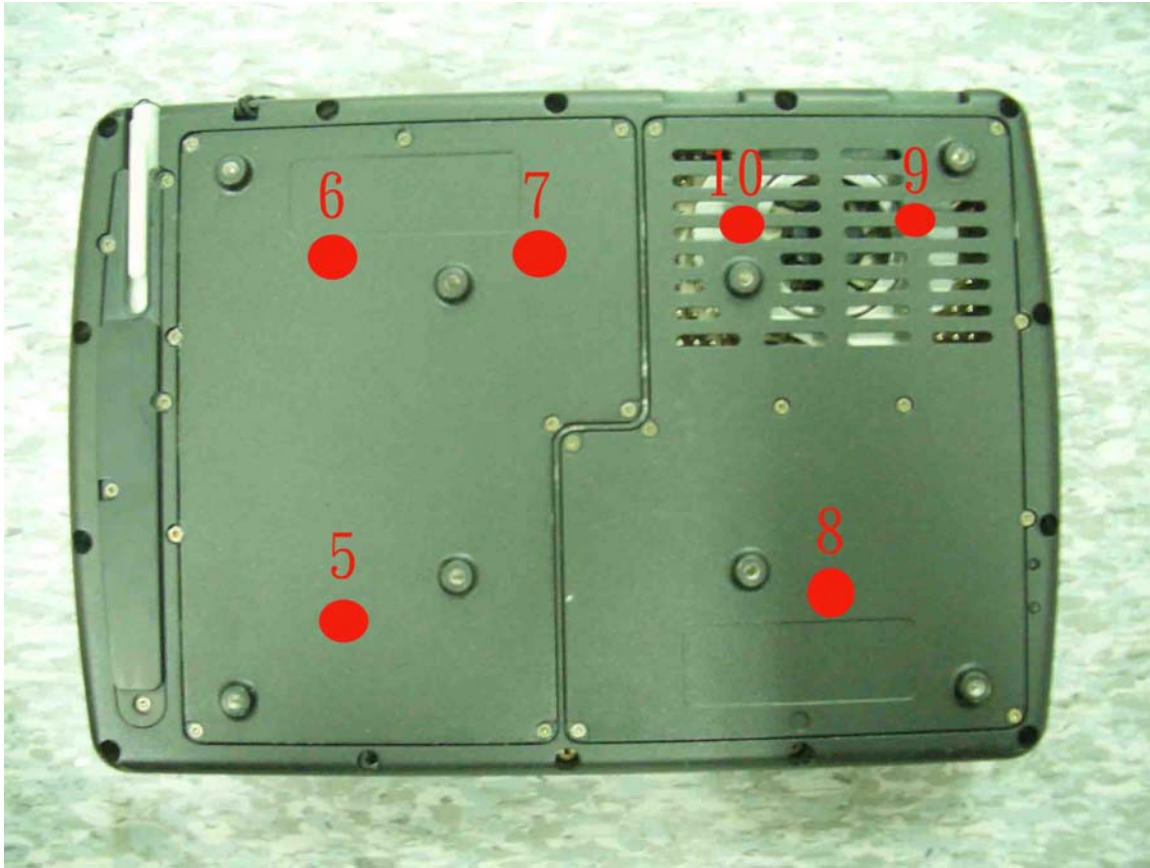
Windows XP Embedded / Run PassMark Burn In Test 4.0 Pro

Terminal Recorder:

Measuring Thermal Couple Position :



Room Temperature test



Thermal profile data:

RTC-1000

Point	Temp. Stage(°C)	Spec	25
1. Point 1		ΔT ≤ 20 $^{\circ}C$	38.1
2. Point 2			35.8
3. Point 3			36.3
4. Point 4			35.2
5. Point 5 - Bottom of Battery			36.1
6. Point 6 - Bottom of Battery			35.7
7. Point 7 - Bottom of RAM			37.0
8. Point 8 - Bottom of HDD			38.1
9. Point 9 - Bottom of FAN (CPU)			34.2
10. Point 10 - Bottom of FAN (NB)			36.4
Room Temperature			24.8
Any Tm value showed in red words which meaning the value over the Tc degree C of this device specification.			

Sample Configuration & Quantity Under Test:

Quantity: 1 (RTC-1000)

Test Result:

No problem was found during the room temperature operation test.

Temperature rise test

Test Date: 08-17-2009

Test Product: RTC-1000

Test Site: AAEON QA Internal Lab.

Test Standard: Reference EN 61131-2(94), UL508 (94)

Temperature Measurement:

40 Channel Thermal Recorder:
YOKOGAWA Inc,
Model: DA100-13-1D
Date of Calibration: 12/13/08
Serial Number: 12A323190

Test Condition:

Ambient temperature: 40dC
Continuous running till thermal stability (within less than 1°C)

Test Software:

Windows XP Embedded / Run PassMark Burn In Test 4.0 Pro

Thermal profile data:

RTC-1000

Point	Temp. Stage(°C)	Spec	35	25
1. CPU		125	61.7	51.7
2. North Bridge		105	59.9	49.9
3. South Bridge		108	76.0	66.0
4. RAM ambient 1 - Between on board RAM & External RAM		85	69.3	59.3
5. RAM ambient 2 - Between External RAM & Bluetooth		85	68.8	58.8
6. WLAN		80	71.6	61.6
7. HDD - Between main board& HDD		60	63.4	53.4
8. U68		120	77.5	67.5
9. U44		--	62.4	52.4
10. U37		70	65.6	55.6
11. U74		--	68.2	58.2
12. Chamber Air Temperature		N/A	35.1	25.1

Any Tm value showed in red words which meaning the value over the Tc degree C of this device specification.

Sample Configuration & Quantity Under Test:

Quantity: 1 (RTC-1000)

Test Result:

No problem was found during the temperature rise operation test. **But operation temperature of HDD was over the specification.**

Test Date: 07-20~27-2009

Test Product: RTC-1000

Test Site: AAEON QA Internal Lab.

Test Standard: Reference MIL-STD 810F Method 501.4 High Temperature
Procedure I - Storage

Test Equipment:

Programmable Temperature & Humidity Chamber

K.SON. INS. TECH. CORP.

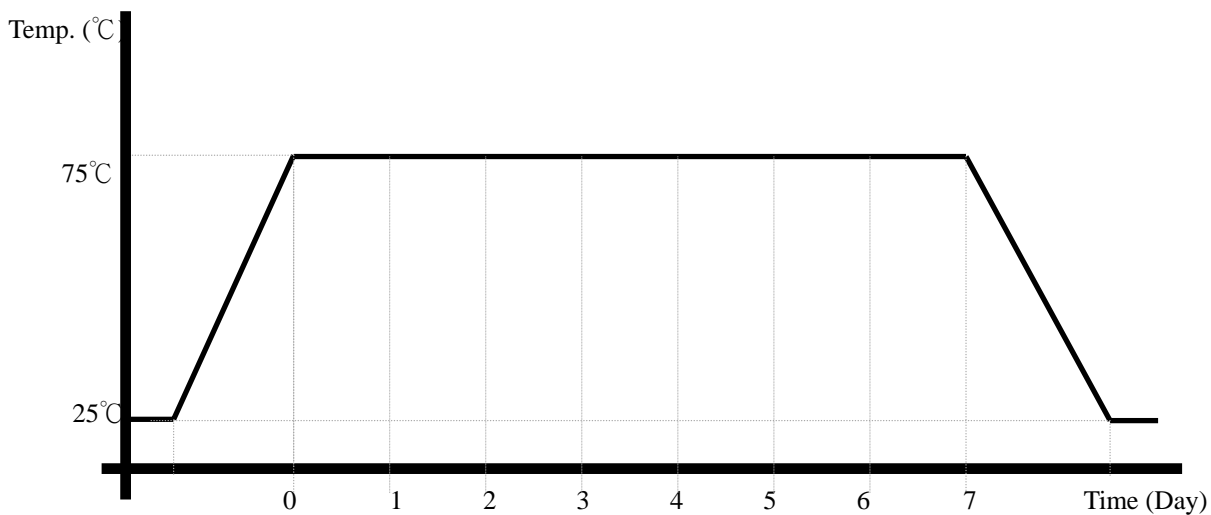
Model: THS-B6T-150+LN2

Date of Calibration: 04/10/09

Serial Number: 6488KT

Testing Item:

1. Test Temperature: 75°C
2. Test Time: 7days
3. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (RTC-1000)

Test Result:

No problem was found after the high temperature storage test.

Test Date: 07-30-2009 ~ 08-04-2009

Test Product: RTC-1000

Test Site: AAEON QA Internal Lab.

Test Standard: Reference MIL-STD 810F Method 501.4 High Temperature
Procedure II - Operation

Test Equipment:

Programmable Temperature & Humidity Chamber

K.SON. INS. TECH. CORP.

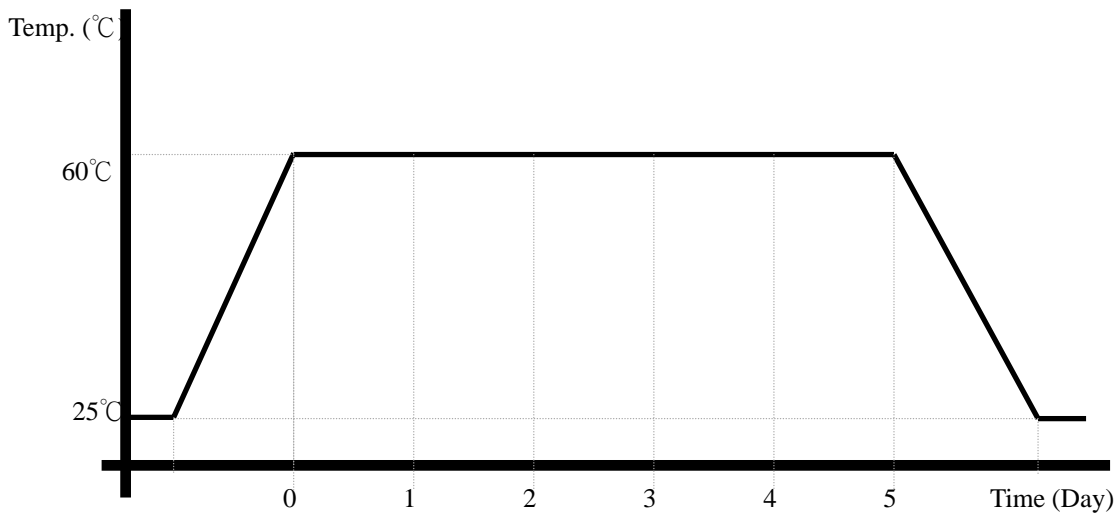
Model: THS-B6T-150+LN2

Date of Calibration: 04/10/09

Serial Number: 6488KT

Testing Item:

4. Test Temperature: 60°C
5. Test Time: 5days
6. Test Software: Windows XP Embedded / Run PassMark Burn In Test 4.0 Pro
7. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (RTC-1000)

Test Result:

No problem was found during the high temperature operation test.

Test Date: 07-28~29-2009

Test Product: RTC-1000

Test Site: AAEON QA Internal Lab.

Test Standard: Reference MIL-STD 810F Method 502.4 Low Temperature
Procedure I - Storage

Test Equipment:
Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-B6T-150+LN2
Date of Calibration: 04/10/09
Serial Number: 6488KT

Testing Item:

1. Test Temperature: -55°C
2. Test Times: 24Hrs
3. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (RTC-1000)

Test Result:

No problem was found after the low temperature storage test.

Test Date: 07-27~28-2009

Test Product: RTC-1000

Test Site: AAEON QA Internal Lab.

Test Standard: Reference MIL-STD 810F Method 501.4 High Temperature
Procedure II - Operation

Test Equipment:
Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-B6T-150+LN2
Date of Calibration: 04/10/09
Serial Number: 6488KT

Testing Item:

1. Test Temperature: -23°C
2. Test Times: 24Hrs
3. Test Software: Windows XP Embedded / Run PassMark Burn In Test 4.0 Pro
4. Test Environment Curve:



Sample Configuration & Quantity Under Test:
Quantity: 1 (RTC-1000)

Test Result:
No problem was found during the low temperature operation test.

Humidity test

Test Date: 08-19~31-2009

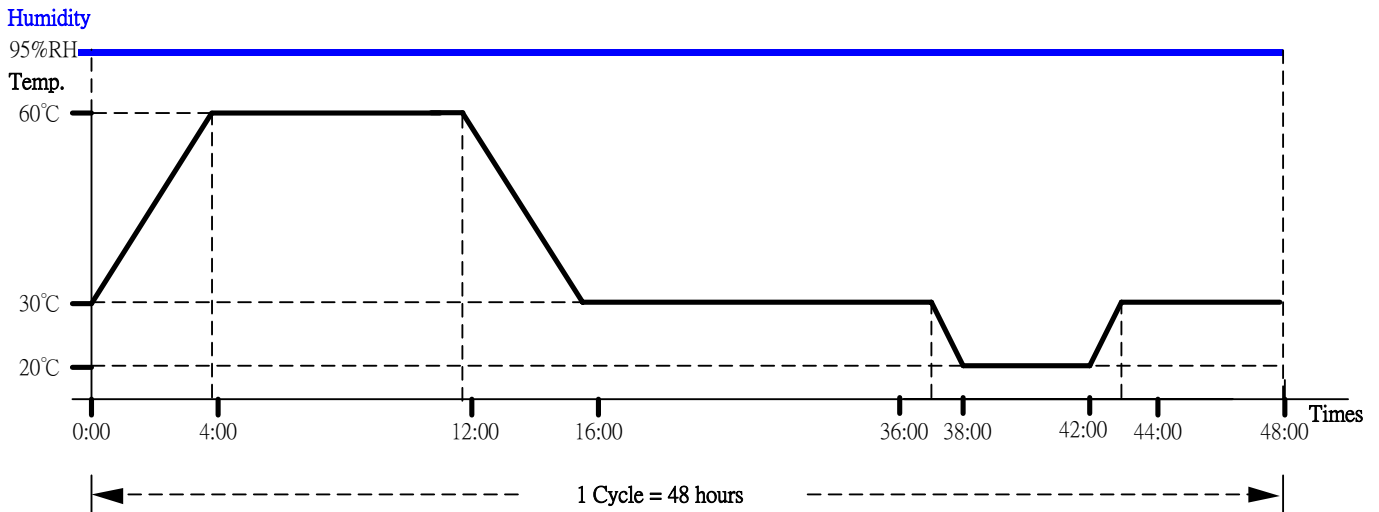
Test Product: RTC-1000

Test Site: AAEON QA Internal Lab.

Test Standard: Reference MIL-STD 810F Method 507.4 Testing procedures
FIGURE 507.4-1. Aggravated temperature-humidity cycle

Test Equipment:
Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-B6T-150+LN2
Date of Calibration: 04/10/09
Serial Number: 6488KT

- Test Condition:**
1. Test Humidity: 95%RH
 2. Test Temperature: 60°C / 30°C / 20°C
 3. Test Times: 48Hrs / Cycle
 4. Test Cycle: 5 Cycles
 5. Test Environment Curve:



Sample Configuration & Quantity Under Test:
Quantity: 1 (RTC-1000)

Test Result:
No problem was found after the humidity storage test.

Test Date: 08-06~07-2009

Test Site: AAEON QA Internal Lab.

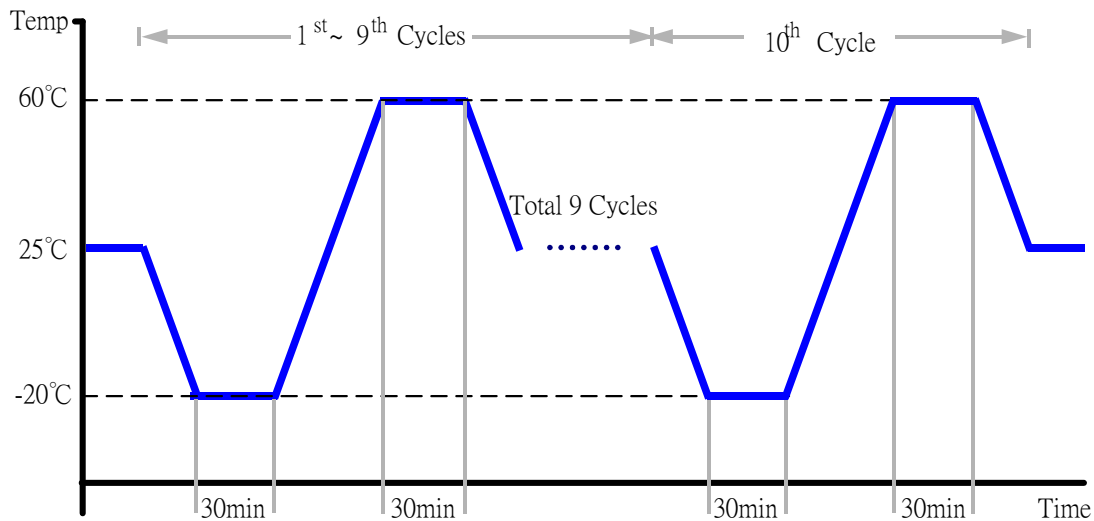
Test Standard: Reference MIL-STD 810F Method 503.4 Temperature Shock
Procedure I - Shock from constant extreme temperatures

Test Equipment:

Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-B6T-150+LN2
Date of Calibration: 04/10/09
Serial Number: 6488KT

Test Condition:

1. Test Low Temperature: -30°C
2. Test High Temperature: 60°C
3. Test dwell time: 15min
4. Temperature slope: 5 min
5. Test cycle: 10 cycles
6. Test Software: Windows XP Embedded / Run PassMark Burn In Test 4.0 Pro
7. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (RTC-1000)

Test Result:

No problem was found during the variation temperature operation test.

Test Date: 08-07~08-2009

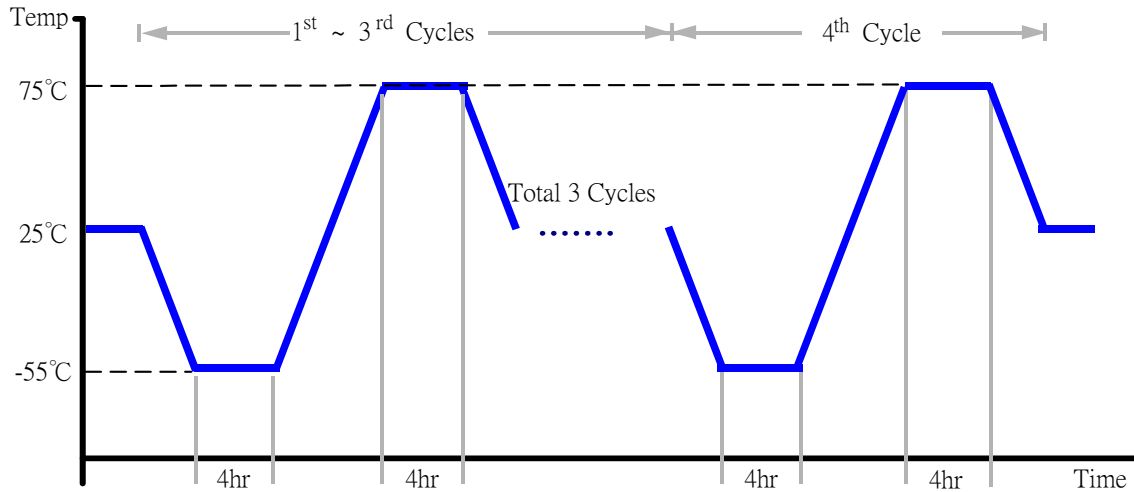
Test Site: AAEON QA Internal Lab.

Test Standard: Reference MIL-STD 810F Method 503.4 Temperature Shock
Procedure I - Shock from constant extreme temperatures

Test Equipment:
Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-B6T-150+LN2
Date of Calibration: 04/10/09
Serial Number: 6488KT

Test Condition:

1. Test Low Temperature: -55°C
2. Test High Temperature: 75°C
3. Test dwell time: 4Hrs
4. Temperature slope: 10 min
5. Test cycle: 4 cycles
6. Test Environment Curve:



Sample Configuration & Quantity Under Test:

Quantity: 1 (RTC-1000)

Test Result:

No problem was found after the variation temperature non-operation test.

Cold start and hot start test

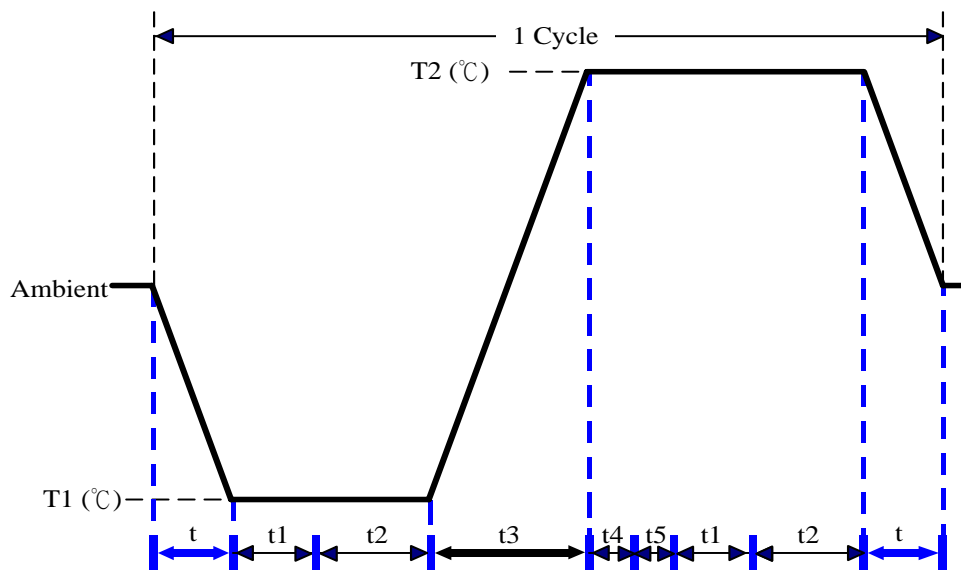
Test Date: 8-04~05-2009

Test Site: AAEON QA Internal Lab.

Test Standard: Reference IEC 68-2-14 Testing procedures
Test N: Change of temperature Test

Test Equipment:
Programmable Temperature & Humidity Chamber
K.SON. INS. TECH. CORP.
Model: THS-B6T-150+LN2
Date of Calibration: 04/10/09
Serial Number: 6488KT

Test Condition:



Parameters	Description
T1	-5°C
T2	45°C
t1	1 hrs
t2	2 hrs
t4, t5	30 min
t, t3	2°C/min
n (Cycle)	1

t, t3 = temprature slope
t, t1: Power Off
t2: Power on/off test 5 times (on 2 min / off 5min)
t3, t4: Run PassMark Burn In Test
t5: Win XP Embedded Software restart test 2 times
Test Software: Windows XP

Test Result:

- a. No problem was found during the cold start test.
- b. No problem was found during the hot start test.